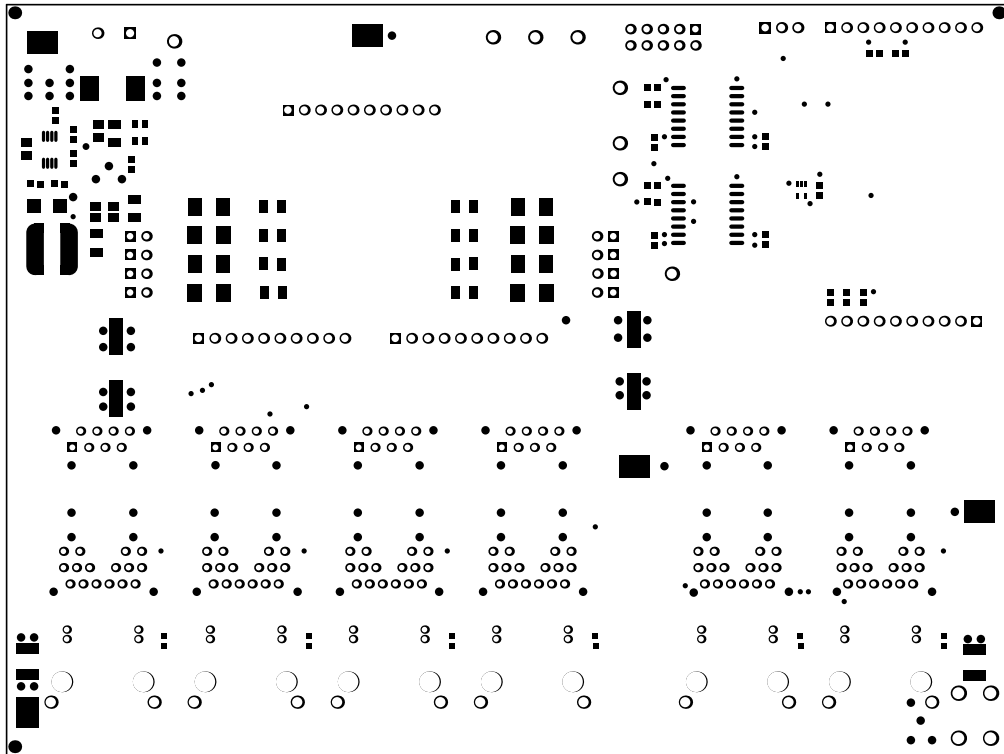
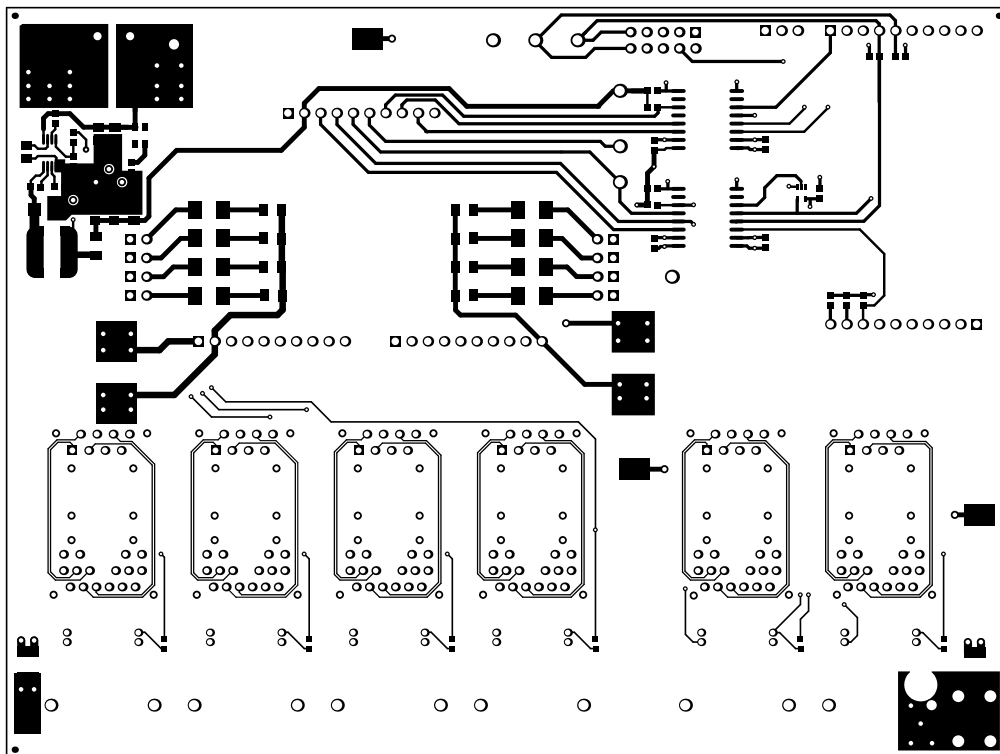


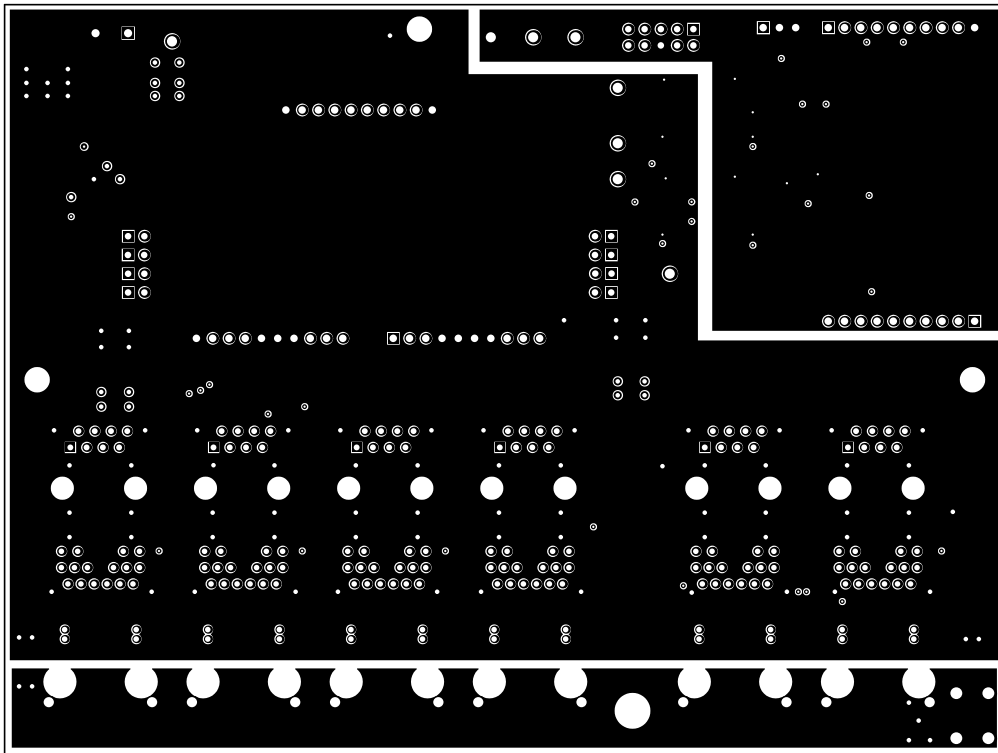
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 2/7/2014	2:44:56 PM	TEXAS INSTRUMENTS



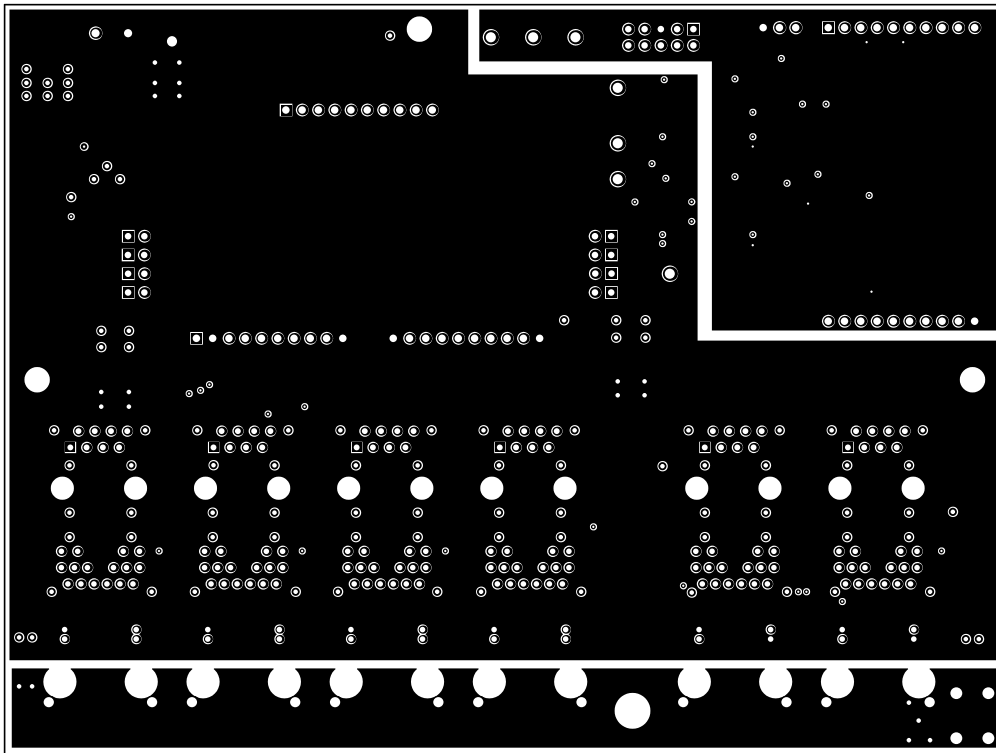
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 2/7/2014 2:44:58 PM	TEXAS INSTRUMENTS	



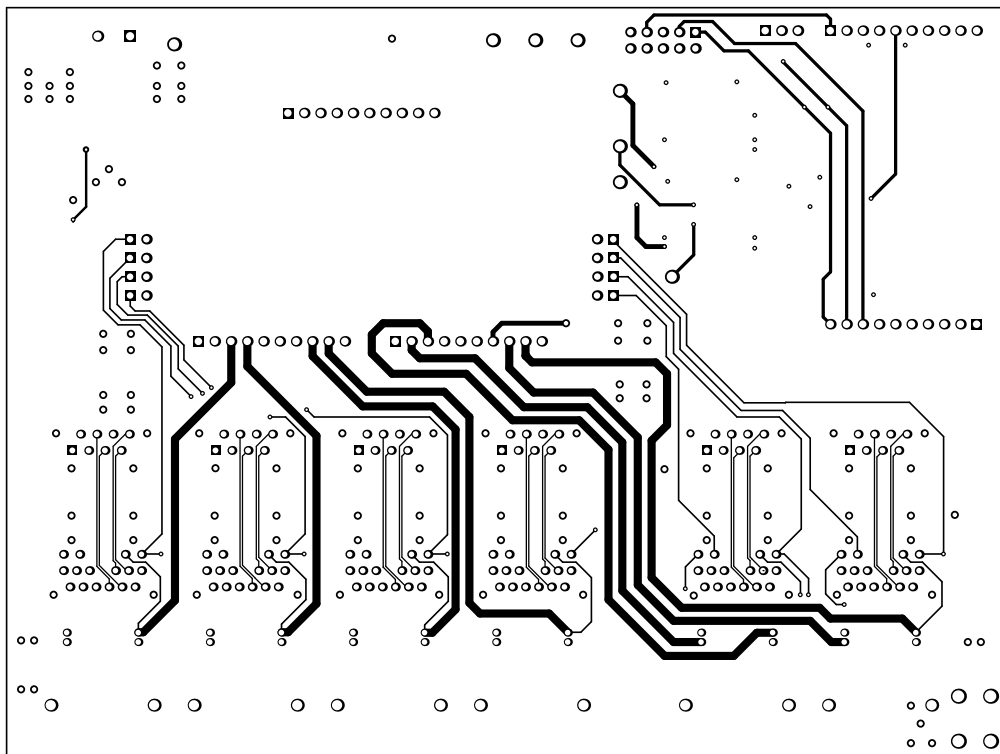
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 2/7/2014	2:44:59 PM	TEXAS INSTRUMENTS



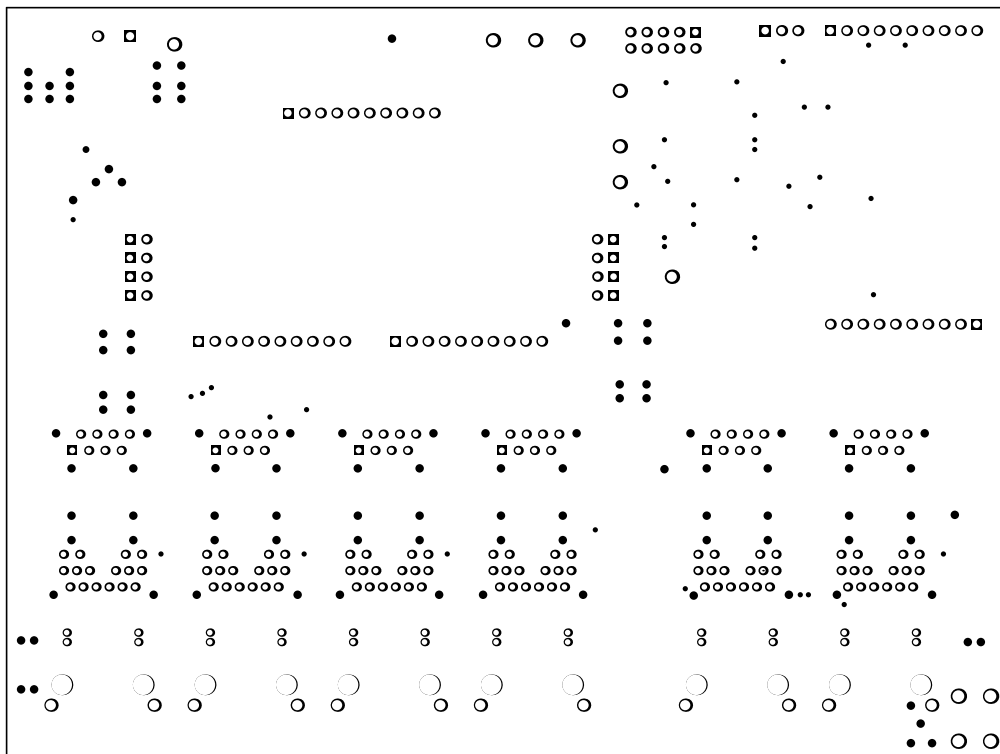
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = MidLayer1	GENERATED : 2/7/2014 2:45:00 PM	TEXAS INSTRUMENTS	



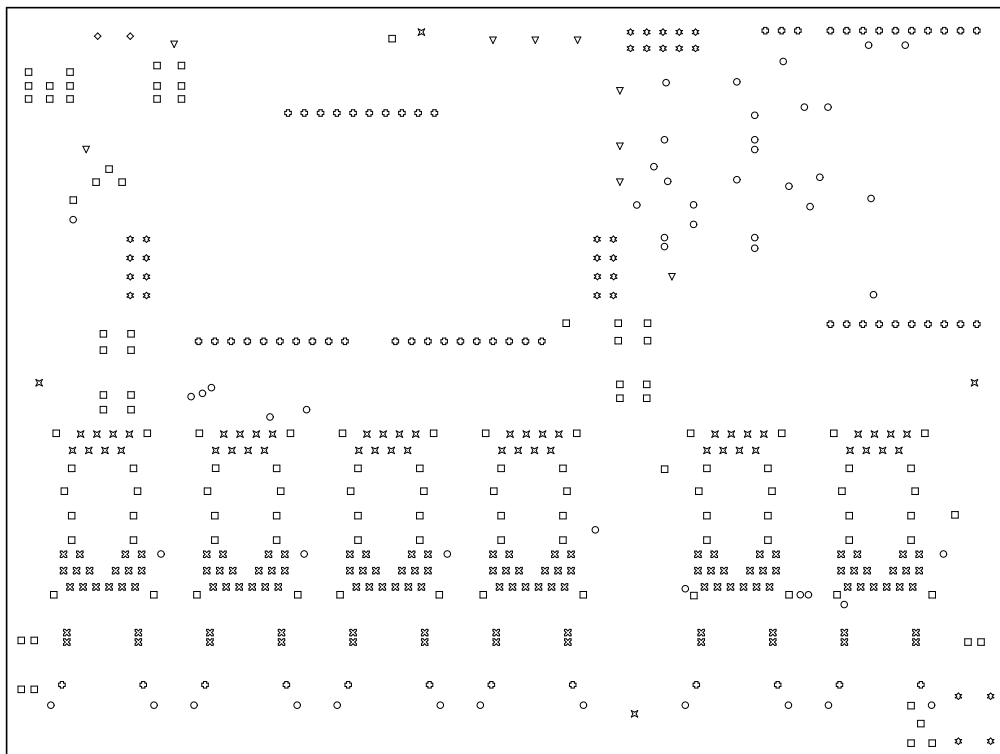
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = MidLayer2	GENERATED : 2/7/2014	2:45:01 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 2/7/2014 2:45:02 PM	TEXAS INSTRUMENTS	



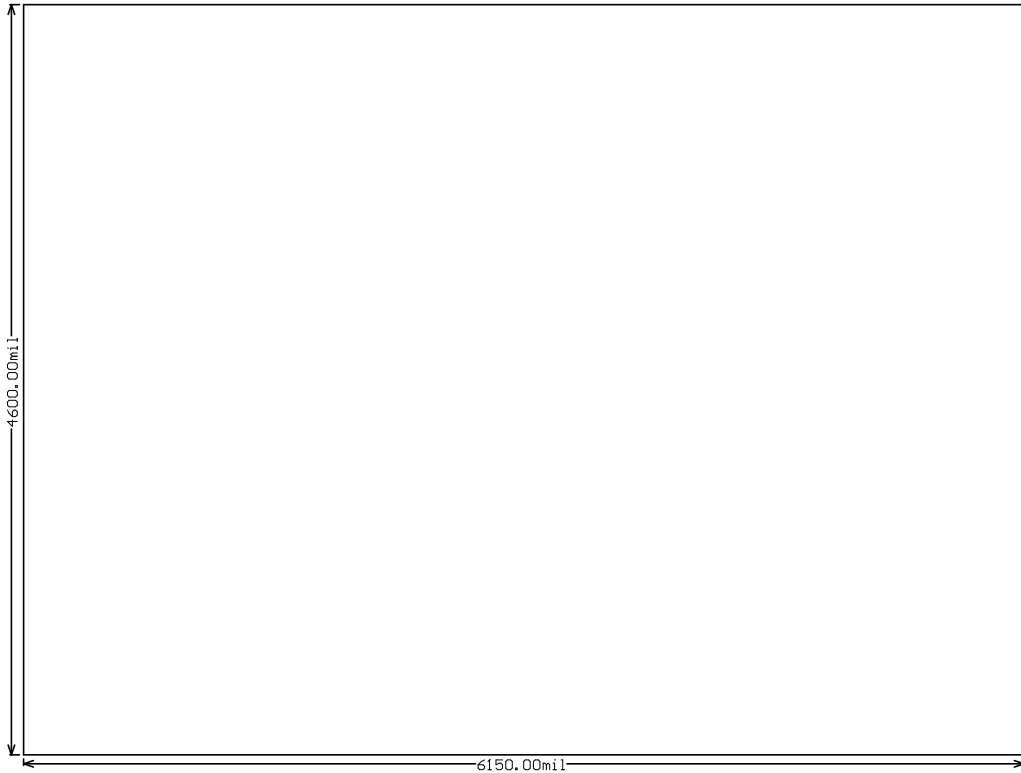
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 2/7/2014 2:45:03 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	41	14mil (0.356mm)	PTH	Round
▽	1	15mil (0.381mm)	PTH	Round
□	108	28mil (0.711mm)	PTH	Round
⊠	120	35mil (0.889mm)	PTH	Round
⊞	48	35.039mil (0.89mm)	PTH	Round
*	26	40mil (1.016mm)	PTH	Round
⊕	53	45.276mil (1.15mm)	PTH	Round
◇	2	49.213mil (1.25mm)	PTH	Round
○	12	62.5mil (1.587mm)	PTH	Round
▽	8	63mil (1.6mm)	PTH	Round
*	4	72.835mil (1.85mm)	PTH	Round
⊕	12	125mil (3.175mm)	NPTH	Round
□	12	128mil (3.251mm)	NPTH	Round
⊞	4	141.732mil (3.6mm)	NPTH	Round
451 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 2/7/2014	2:45:04 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR612	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 2/7/2014 2:45:05 PM	TEXAS INSTRUMENTS	

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